

09-07-2001



Tab settings

To the Honorable Commissioner of Patents

101835971

Attached original documents or copy thereof.

1. Name of conveying party(ies):

Takamasa ITO

08/27/01

Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):

Name: NEC CORPORATION

Address: 7-1, Shiba 5-chome

City: Minato-ku

State/Prov.: Tokyo

Country: JAPAN

ZIP:

10978 U.S. PTO
09/940247

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: March 27, 2001

Additional name(s) & address(es) Yes No

4. Application number(s) or registration numbers(s):

09940247

If this document is being filed together with a new application, the execution date of the application is: March 27, 2001

Patent Application No. Filing date

B. Patent No.(s)

08/30/2001 NHCHAMM1 00000048 09940247
02 FC:581 40.00 OP

Additional numbers

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Norman P. Soloway

Registration No. 24,315

Address: Hayes, Soloway, Hennessey, Grossman & Hage, PC

175 Canal Street

City: Manchester

State/Prov.: NH

Country: USA

ZIP: 03101

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
- Authorized to be charged to deposit account

8. Deposit account number:

08-1391

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Norman P. Soloway

Norman P. Soloway

August 27, 2001

Name of Person Signing

Signature

3

Date

Total number of pages including cover sheet, attachments, and

PATENT

ASSIGNMENT

FOREIGN - IN THE UNITED STATES OF AMERICA

I/we Takamasa ITO

~~of~~ c/o NEC CORPORATION, 7-1, Shiba 5-chome, Minato-ku, Tokyo, JAPAN

having invented certain inventions and improvements in _____

Method for forming a silicide layer

and having executed an application for Letters Patent of the United States of America describing the same and based thereon on March 27, 2001;

for good and valuable consideration, the receipt of which is hereby acknowledged from **NEC CORPORATION**, a Japanese corporation having its principal place of business at 7-1, Shiba 5-chome, Minato-Ku, Tokyo, Japan, (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my/our entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United states of America;

And for the same consideration I/we do agree that I/we will upon request execute any instrument which the Assignee may desire to carry this Assignment into effect and perfect the title transferred hereby or prosecute the above-mentioned application;


And I/we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent on the said application to the Assignee;

And I/we do hereby jointly and severally covenant for ourselves and for our legal representatives that I/we have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I/we have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we hereunto set our hands and seals on the day and year

hereinafter noted.

Sole or first

Inventor's signature Takamasa Ito  Date March 27, 2001

Full name (typed or printed) Takamasa ITO

Witness: Hiteshi Ukei Witness: [Signature]

Date: _____ Date: _____

Second Inventor's

signature _____ Date _____

Full name (typed or printed) _____

Witness: _____ Witness: _____

Date: _____ Date: _____

Third Inventor's

signature _____ Date _____

Full name (typed or printed) _____

Witness: _____ Witness: _____

Date: _____ Date: _____

Fourth Inventor's

signature _____ Date _____

Full name (typed or printed) _____

Witness: _____ Witness: _____

Date: _____ Date: _____